



## Description

■ This device is an ultra low capacitance ESD product designed to protect very high speed data interfaces. ESDPSA0402V18 has a typical capacitance of only 0.05pf (I/O to GND), and it can be used to meet the ESD immunity requirements of IEC61000-4-2 (15KV air, 8KV contact discharge).

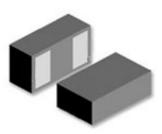
## Feature

- ESD protection for high speed data lines to IEC61000-4-2
- ESD contact discharge typical 8KV, max 15KV
- ESD air discharge typical 15KV, max 25KV
- Surface mount
- Extremely low capacitance
- Very low leakage current
- Fast response time
- Bi-directional ESD protection
- Lead free solder termination
- The best ESD protection for high frequency, low voltage applications
- RoHS compliant & Halogen free

# Application

- High Definition Multi-Media Interface (HDMI)
- Digital Visual Interface (DVI)
- Display Port Interface (DP)
- Unified Display Interface (UDI)
- Mobile Display Digital Interface (MDDI)
- Gigabit Ethernet
- USB2.0 and USB3.0
- IEEE1394 interface

# ESDPSA0402V18





Schematic Diagram



## **Absolute Maximum Ratings**

Parameter	Symbol	Value	Unit
Maximum Contact discharge voltage Per IEC61000-4-2		15KV	V
Maximum Air discharge voltage Per IEC61000-4-2		25KV	V
Maximum Operating temperature	T <sub>OPER</sub>	-55 to +125	°C
Maximum Storage temperature	T <sub>STG</sub>	-55 to +125	°C
Maximum lead temperature for soldering during 10s	Τι	260	°C

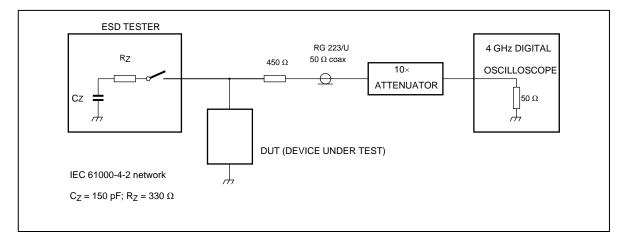
## **Electrical Characteristics(T<sub>A</sub>=2**5°C)

Parameter	Symbol	Test Conditions	Min	Тур	Max	Units
Rated Voltage	Vr				18	V
Trigger voltage	VT	IEC61000-4-2 8KV contact discharge		300		V
Clamping voltage	Vc	IEC61000-4-2 8KV contact discharge		35		V
Leakage current	IL.	DC 18V shall be applied on component		0.01	0.10	uA
Capacitance	СР	$V_R = 0V, f = 1MHz$		0.05		pF

Note: 1 Trigger and clamping voltage are measured per IEC 61000-4-2, 8KV contact discharge method.

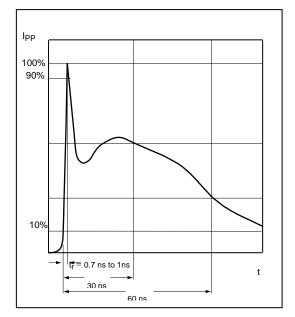
2 After reliability tests such as high temp storage, temp cycles, continuous ESD strike etc, the maximum leakage current is less than 10uA.

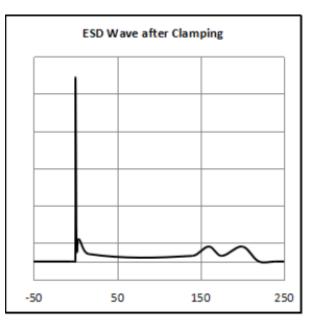
# **ESD Clamping Test**



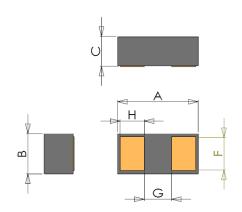


# **ESD Clamping Test Waveforms**





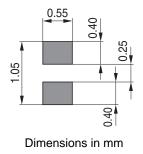
## **Product Dimension**



Symbol	Dimension			11:0:4	
	Min	Тур	Мах	Unit	
А	0.95	1.0	1.05		
В	0.45	0.50	0.55	mm	
С	0.32	0.36	0.40		
н	0.28	0.30	0.32		
F	0.41	0.43	0.45		
G	0.32	0.34	0.36		

# **ESD Protection Devices**

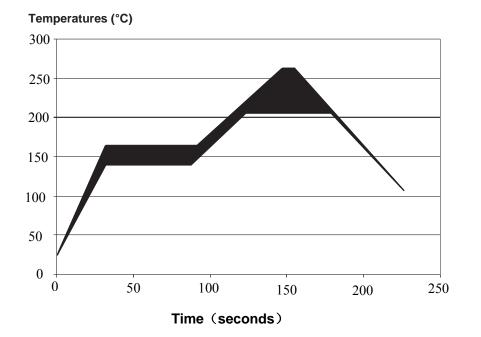
## **PAD Dimension**



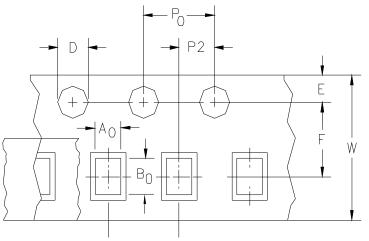
Solder thickness 0.08 to 0.12mm recommended



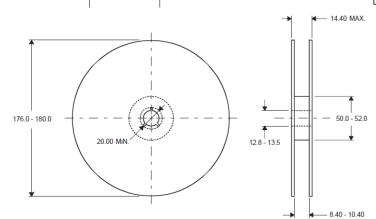
## **Solder Reflow Recommendations**



## **Package Information**



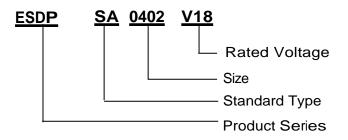
Dimension	Typical	Unit
A0	0.68	
B0	1.17	
D	1.55	
P0	4.00	
P1	2.00	
P2	2.00	mm
Е	1.75	
F	3.50	
W	8.00	



DIMENSIONS ARE: MILLIMETERS



## Part Number System



## **Order Information**

Device	Package	Net Weight	Carrier	Quantity	HSF Status
ESDPSA0402V18	0402	0.44 mg	Tape & Reel	10,000pcs/reel	RoHS compliant

## **Revision history**

Date	Revision	Description of changes
Jan. 2021	6.0	Update

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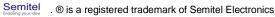
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